# SPECIFICATION FOR LCD MODULE

Model No. TM240128CDBW

Prepared by:	Date:
Checked by :	Date:
Verified by :	Date:
Approved by:	Date:

TIANMA MICROELECTRONICS CO., LTD

## **REVISION RECORD**

Date	Ref. Page	Revision No.	<b>Revision Items</b>	Check & Approval

### **1. General Specifications:**

1.1 Display type: STN

1.2 Display color\*:Display color: Blue-BlackBackground: Grey

1.3 Polarizer mode: Transflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/128

1.6 Backlight: EL

1.7 Operating Temperature:-20----+70Storage Temperature:-30-----+80

### 2. Mechanical Specifications

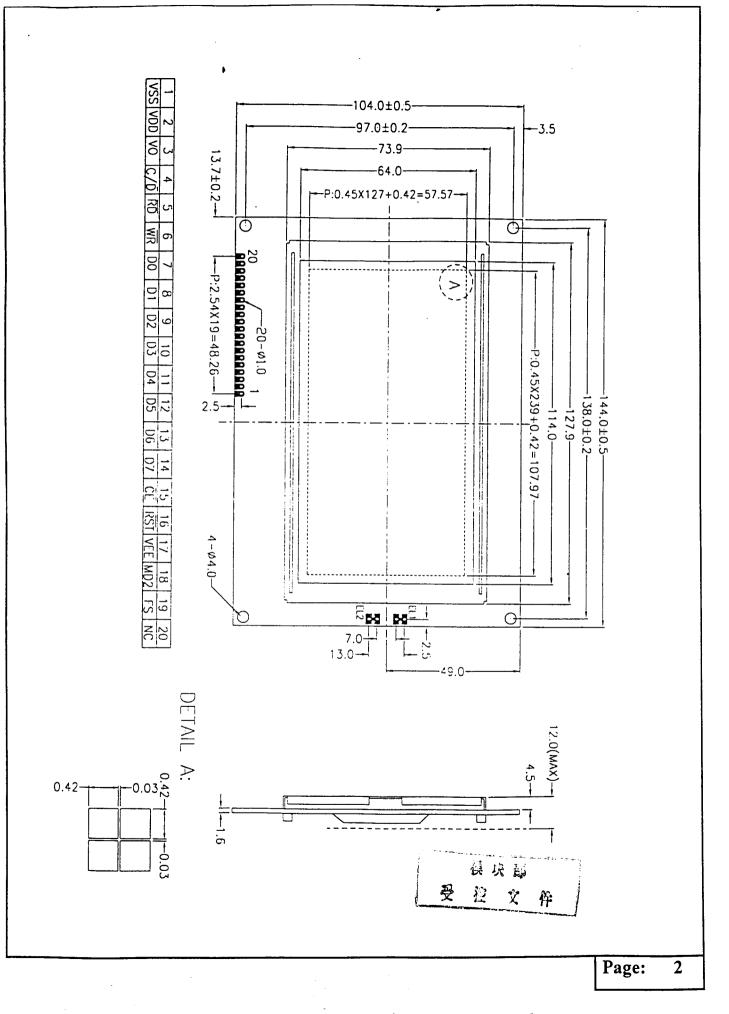
2.1 Outline Dimensions: Refer to outline drawing on next page

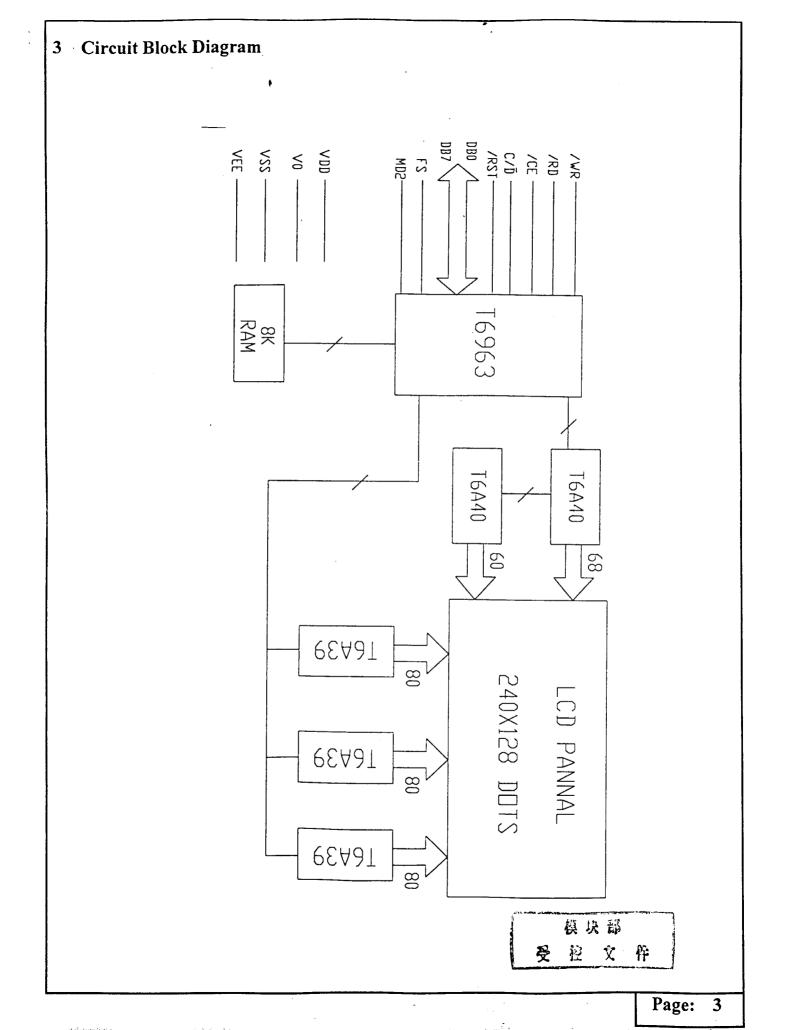
2.2 Dot Matrix: 240 X 128 Lines

- 2.3 Dot Size: 0.42X0.42(mm)
- 2.4 Dot Pitch: 0.45X0.45 (mm)

2.5 Weight: 140g

• Color tone is slightly changed by temperature and driving voltage.





# 4 Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	VDD-VSS	-0.3	6.0		
LCD Driving Voltage	Vdd-Vee	١.	25.0	V	
Operating Temperature Range	T <sub>OP</sub>	-20	+70		No
Storage Temperature Range	T <sub>ST</sub>	-30	+80	°C	Condensation

# 5 Electrical Specifications and Instruction Code

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5.1 Electrical characteristics

Item	l	Symbol	Min.	Тур.	Max.	Uni	Remark
	Supply Voltage (Logic)		4.75	5.0	5.25	t V	
Supply Vo (LCD D	-	Vdd-Vee	-	18.5	-	V	
Input Signal	'H'Level	V <sub>IH</sub>	$0.8 \mathrm{V_{DD}}$	-	V <sub>DD</sub> +0.3	V	
Voltage			0	-	$0.2 V_{\text{DD}}$	V	
Supply curren	Supply current (Logic)		-	-	8.0	mA	
Supply cu (LCD Dr		I <sub>EE</sub>	-	-	3.0	mA	
Supply cu (EL Dri		Ibl	-	-	11.3	mA	

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# 5.2 Interface Signals

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Pin No.	Symbol	, Level	Description
1	VDD	5.0V	Power supply voltage for logic (+5V)
2	VSS	0V	Ground
3	V00	-13.5V	Operating voltage for LCD(-)(variable)
4	C/D	H/L	
	RD		Command/Data Signal
5		H/L	Read Enable Signal
6	WR	H/L	Write Enable Signal
7	<b>D</b> 0	H/L	Data bit0
8	D1	H/L	Data bit1
9	D2	H/L	Data bit2
10	D3	H/L	Data bit3
11	D4	H/L	Data bit4
12	D5	H/L	Data bit5
13	D6	H/L	Data bit6
14	<b>D7</b>	H/L	Data bit7
15	ĊE	H/L	Chip Enable Signal
16	RST	H/L	Reset Signal
17	VEE	-13.0V	Power supply voltage for LCD(-)
18	MD2	H/L	Columns number Selection
19	FS	H/L	Font Selection
20	NC		

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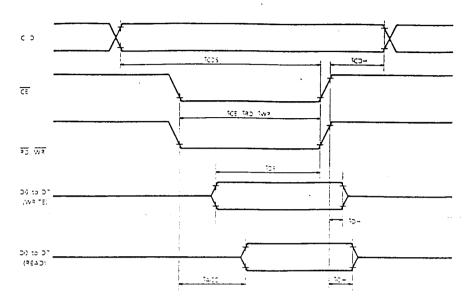
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# 5.3 Interface Timing Chart:

**Bus Timing** 

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### TEST CONDITIONS (Unless otherwise noted, $V_{DD} = 5.0 \times \pm 10^{12}$ , $V_{SS} = 0V$ , Ta = -20 to $75^{\circ}C$ )

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ITEM	SYMBO_	TEST CONDITIONS	: MiN	MAX	UNIT
C/D Set-up Time	tcos		100	_	ns.
C/D Hold Time	100H		10	_	ns
CE, RD, WR Pulse Width	I tCE, tRD, tWR		80		ns
Data Set-up Time	t DS		80		ns
Data Hold Time	срн		i 40	_	ns
Access Time	tACC		- 1	150	ns
Output Hold Time	tou	_	10	50	ns

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# 5.4 Instruction Code

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COMMAND	CODE	D1	D2	FUNCTION
	00100001	X address	Y address	Set Cursor Pointer
REGISTERS SETTING	00100010	Data	оон	Set Offset Register
	00100100	Low address	High address	Set Address Pointer
	01000000	Low address	High address	Set Text Home Address
	01000001	Columns	оон	Set Text Area
SET CONTROL WORD	01000010	Low address	High address	Set Graphic Home Address
	01000011	Columns	оон `	Set Graphic Area
	1000X000	-		OR mode
	1000X001	-	- I	EXOR mode
	1000X011	-	_	AND mode
MODE SET	1000X100	_	_	Text Attribute mode
	10000XXX			Internal CG ROM mode
	10001XXX	_		External CG RAM mode
	10010000	_	-	Display off
	1001XX10	_	_	Cursor on, blink off
	1001XX11			Cursor on, blink on
DISPLAY MODE	100101XX	_	_	Text on, graphic off
	100110XX		_	Text off, graphic on
	100111XX	_		Text on, graphic on
	10100000		_	1-line cursor
	10100001	_		2-line cursor
,	10100010	_	_	3-line cursor
CURSOR PATTERN	10100011	_		4-line cursor
SELECT	10100100	_		5-line cursor
	10100101	_	-	6-line cursor
	10100110	_		7-line cursor
	10100111	_	_	8-line cursor
	10110000	_	_	Set Data Auto Write
DATA AUTO READ/	10110001	_	_	Set Data Auto Read
WRITE	10110010		_	Auto Reset
	11000000	Data		Data Write and Increment ADP
	11000001	_		Data Read and Increment ADP
	11000010	Data	_	Data Write and Decrement ADP
DATA READ/WRITE	11000011	_		Data Read and Decrement ADP
	11000100	Data	_	Data Write and Nonvariable ADP
	11000101	_	_	Data Read and Nonvariable ADP
SCREEN PEEK	11100000			Screen Peek
SCREEN COPY	11101000			Screen Copy
	11110XXX	_		Bit Reset
	11111XXX		_	Bit Set
	1111X000		_	Bit 0 (LSB)
	1111X001			Bit 1
	1111X010		_	Bit 2
BIT SET/RESET	1111X011	_	_	Bit 3
	1111X100	_		Bit 4
	1111X101		_	Bit 5
	1111X110		_	Bit 6

X : invalid



Page: 7

5.5 Character Code Map

LSB VISB	0	1	2	3	4	5	6	7	8	9	A	8	c	D	E	F
0					•••••	••••							:	*****		
1				·	: <b>.</b>	·		:		·!	#	# ;;		82994 28992		
2																
3	<b>.</b> ;			·			<b>!</b> ,, <b>!</b>		· · ·	1.1	:	<b>.</b>				
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7					::::		.'. !!	· · ·								

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CG ROM TYPE 0201

LSB	0	1	2	3	. 4	5	6	7	8	9	A	В	c	D	E	F
0									1				:	••••	::	
1				••	<b>:</b>			;		•	11 11	;;				
2										•						
3	<sup>1</sup>		<b>]</b>									ļ.,	•••			
4				••••••	•			*****			*****		17		****	1
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Page: 8

# 6.Optical Characteristics

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# 6.1 Optical Characteristics

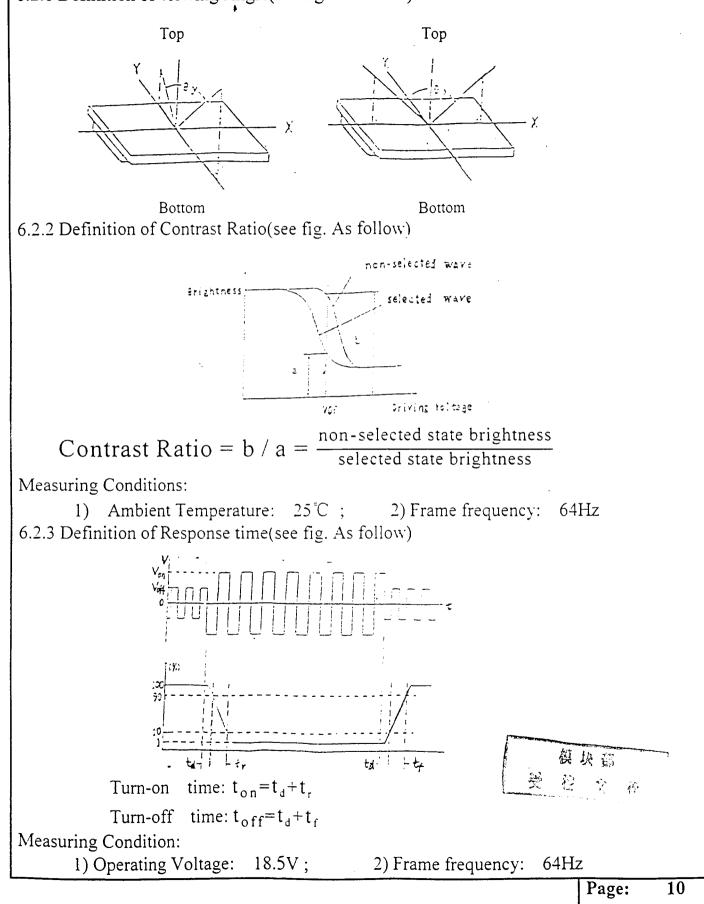
Top=25℃

Iter	n	Symbol	Condition		Min.	Тур.	Max.	Unit	Remark
Viewing	iewing Angle $\theta_x$		Cr≥2	$\theta_y=0^{\circ}$	-30~30			Пед	
		θγ		$\theta_x = 0^{\circ}$		-30~20	)	Deg	
Contrast	Ratio	Cr	$\theta_x = 0^\circ$ $\theta_y = 0^\circ$		3.0				
Response Time	Turn on	Ton	θχ	$x=0^{\circ}$			300	ms	
	Turn off	Toff		-			300		

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- 6.2 Definition of optical characteristics
- 6.2.1 Definition of viewing Angle(see fig. As follow)



# 7. Reliability

# 7.1 Content of Reliablity Test

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 $(T_{OP}=25^{\circ}C)$ 

No.	Test Item	Content of Test	Test condition	
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	80℃ 240H	
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-30℃ 240H	
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	70℃ 240H	
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	-20℃ 240H	
5	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	60℃ 95%RH 240H	
6	Temperature Cycle	Endurance test applying the low and high temperature cycle $-30^{\circ}C \longrightarrow 25^{\circ}C \longrightarrow 80^{\circ}C \longrightarrow 25^{\circ}C$ 30min 5min 30min 5min 1 cycle	-30°C/80°C 10 cycles	
7	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~500Hz, 100m/s², 120min	
	Shock Test (package state)	Endurance test applying the shock during transportation	Half-sinewave, 300m/s², 18ms	
	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	25kPa 16H	
			2 Page: 11	

# 7.2 Failure Judgment Criterion

Criterion Item		Test Item No.								Failure Judgement Criterion	
	1	2	3	4	5	6	7	8	9		
Basic Specification	0	0	0	0	0	0	0	0	0	Out of the basic Specification	
Electrical Specification	0	0	0	0	0					Out of the electrical specification	
Mechanical Specification							0	0		Out of the mechanical specification	
Optical Characteristic	0	0	0	0	0	0			0	Out of the optical specification	
Remark Basic specification = Optical specification + Mechan specification						tical specification + Mechanical					

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### 8 Precautions for use of LCD Modules

- 8.1 Handling Precautions
- 8.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 8.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 8.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 8.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 8.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

---Isopropyl alcohol

— Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

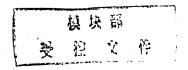
— Water

—Ketone

-Aromatic solvents

- 8.1.6 Do not attempt to disassemble the LCD Module.
- 8.1.7 If the logic circuit power is off, do not apply the input signals.
- 8.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - a. Be sure to ground the body when handling the LCD Modules.
  - b. Tools required for assembly, such as soldering irons, must be properly ground.
  - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

Page: 13



- 8.2 Storage precautions
- 8.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 8.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

temperature :  $0^{\circ}$ C ~  $40^{\circ}$ C relatively humidity:  $\leq 80\%$ 

- 8.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 8.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

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